



## SPECIFICATION

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SPEC. NO.: PS-50019-XXXXX-XXX REVISION: B

PRODUCT NAME: 0.5mm PITCH BTB SMT S/T D/R CONNECTOR

PRODUCT NO: 50019 Series;50020 Series;50031 Series;50149 Series;50152 Series

PREPARED:  <b>TANGENHUI</b>  DATE: <b>2014/01/18</b>	CHECKED:  <b>DAVID</b>  DATE: <b>2014/01/18</b>	APPROVED:  <b>SIMON</b>  DATE: <b>2014/01/18</b>
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2010/10/31 TR-FM-73015L



TITLE: 0.5MM PITCH BTB SMT S/T D/R CONNECTOR

RELEASE DATE: 2014.01.18

REVISION: B

ECN No: ECN-1401255

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Aces P/N: **50019 series**

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## 1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
O	<a href="#">ECN-0812036</a>	<a href="#">NEW SPEC</a>	<a href="#">JASON</a>	<a href="#">2008/12/06</a>
A	<a href="#">ECN-1304407</a>	<a href="#">UPDATE</a>	<a href="#">XIAOXIONG</a>	<a href="#">2013/04/29</a>
B	<a href="#">ECN-1401255</a>	<a href="#">ADD WORKING VOLTAGE</a>	<a href="#">TANGENHUI</a>	<a href="#">2014/01/18</a>

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## 2 SCOPE

This specification covers performance, tests and quality requirements for [0.50mm pitch BTB connector](#).

## 3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

## 4 REQUIREMENTS

### 4.1 Design and Construction

- 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

### 4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy ([Phosphor Bronze](#))  
Finish: (a) Contact Area: [Refer to the drawing](#).  
(b) Under plate: [Refer to the drawing](#).  
(c) Solder area: [Refer to the drawing](#).
- 4.2.2 Housing: Thermoplastic High Temp., UL94V-0

### 4.3 Ratings

- 4.3.1 [Working Voltage Less than 36 Volts AC \(per pin\)](#)
- 4.3.2 Voltage: [50 Volts AC \(per pin\)](#)
- 4.3.3 Current: [0.5 Amperes \(per pin\)](#)
- 4.3.4 Operating Temperature : [-40°C to +80°C](#)

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## 5 Performance

### 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
<b>ELECTRICAL</b>		
Item	Requirement	Standard
Low Level Contact Resistance	55 m $\Omega$ Max.(initial)per contact $\Delta R$ 10 m $\Omega$ Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	500 M $\Omega$ Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)
<b>MECHANICAL</b>		
Item	Requirement	Standard
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 $\pm$ 3mm/min. (EIA-364-09)

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Mating / Unmating Forces	Unit: Kg						Operation Speed : 25.4 ± 3 mm/minute.. Measure the force required to mate/unmate connector. (EIA-364-13)
	Pins	Mating Force(Max)		Unmating Force(Min)			
		Initial	Final	Initial	Final		
<20	2.0	1.0	0.2	0.2			
22~40	2.0	1.0	0.4	0.3			
42~80	5.0	4.0	0.5	0.4			
82~120	5.0	4.0	0.8	0.6			
122~200	8.0	6.0	0.8	0.6			
Terminal / Housing Retention Force	0.2kgf MIN.						Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with tester.
Fitting Nail /Housing Retention Force	0.2kgf MIN.						Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with tester.
Vibration	1 μs Max.						The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of <b>10 and 55 Hz</b> . The entire frequency range, from <b>10 to 55 Hz</b> and return to <b>10 Hz</b> , shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.						Subject mated connectors to <b>50 G's</b> (peak value) <b>half-sine</b> shock pulses of <b>11</b> milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

**ENVIRONMENTAL**

Item	Requirement	Standard
Resistance to <b>Reflow</b> Soldering Heat	See Product Qualification and Test Sequence Group 9 (Lead Free)	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max, 10sec Max. <b>Reflow number cycle: 2 times</b>

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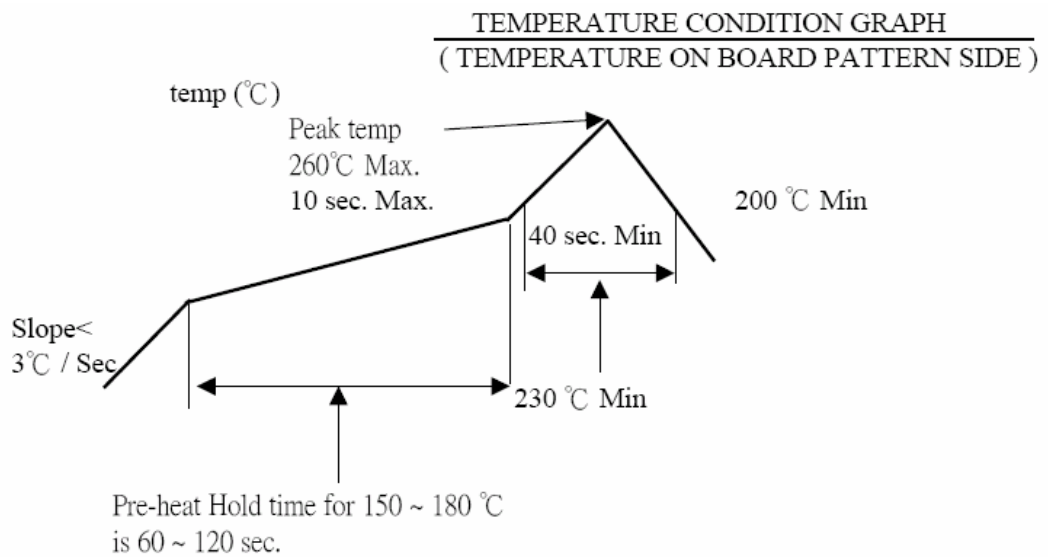
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Thermal Shock	See Product Qualification and Test Sequence Group <b>3</b>	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group <b>3</b>	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31, Condition A, Method II)
Temperature life	See Product Qualification and Test Sequence Group <b>4</b>	Subject mated connectors to temperature life at <b>85°C</b> for <b>96 hours</b> . (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group <b>5</b>	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C <b>(I) Gold flash for 8 hours</b> <b>(II) Gold plating 5 u" or over for 96 hours</b> . (EIA-364-26)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	And then into solder bath, Temperature at <b>245 ±5°C</b> , for <b>4-5</b> sec. (EIA-364-52)

**Note.** Flowing Mixed Gas shall be conducted by customer request.

## 6 INFRARED REFLOW CONDITION

### 6.1. Lead-free Process





## 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group									
	1	2	3	4	5	6	7	8	9	
	Test Sequence									
Examination of Product				1、7	1、6	1、4			1	
Low Level Contact Resistance		1、5	1、4	2、10	2、9	2、5			3	
Insulation Resistance				3、9	3、8					
Dielectric Withstanding Voltage				4、8	4、7					
Mating / Unmating Forces		2、4								
Temperature rise	1									
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Fitting Nail /Housing Retention Force								2		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	

单击下面可查看定价，库存，交付和生命周期等信息

[>>ACES\(宏致\)](#)